

specification

Customer : Ryder Electronics (Shenzhen) Ltd.

Customer P/N:

Part Name: PCB built-in aerial

HJ P/N: 3N0301BK-068

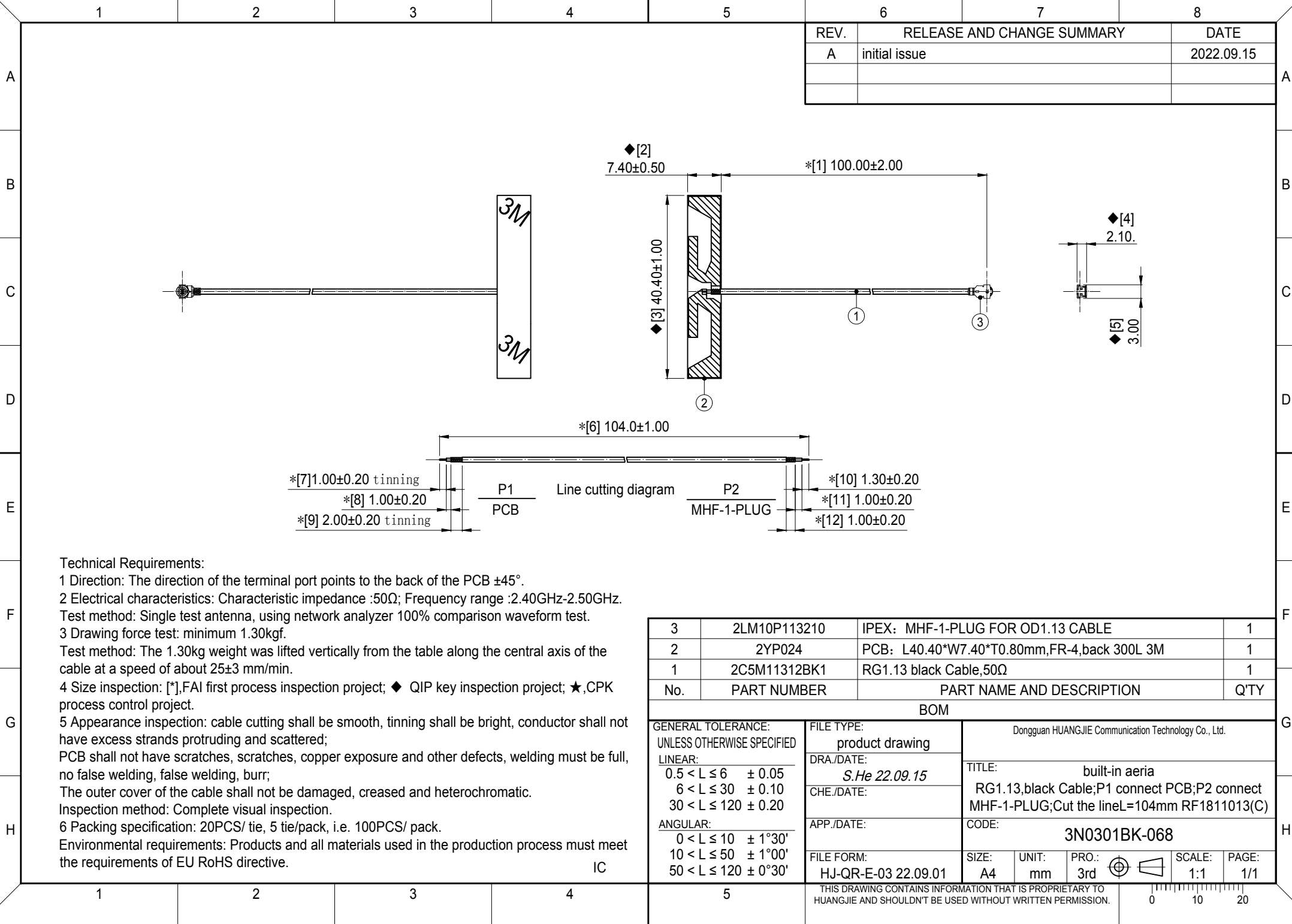
Spec Description : RG1.13,black Cable;P1 connect PCB;P2
connect MHF-1-PLUG;Cut the
lineL=104mm

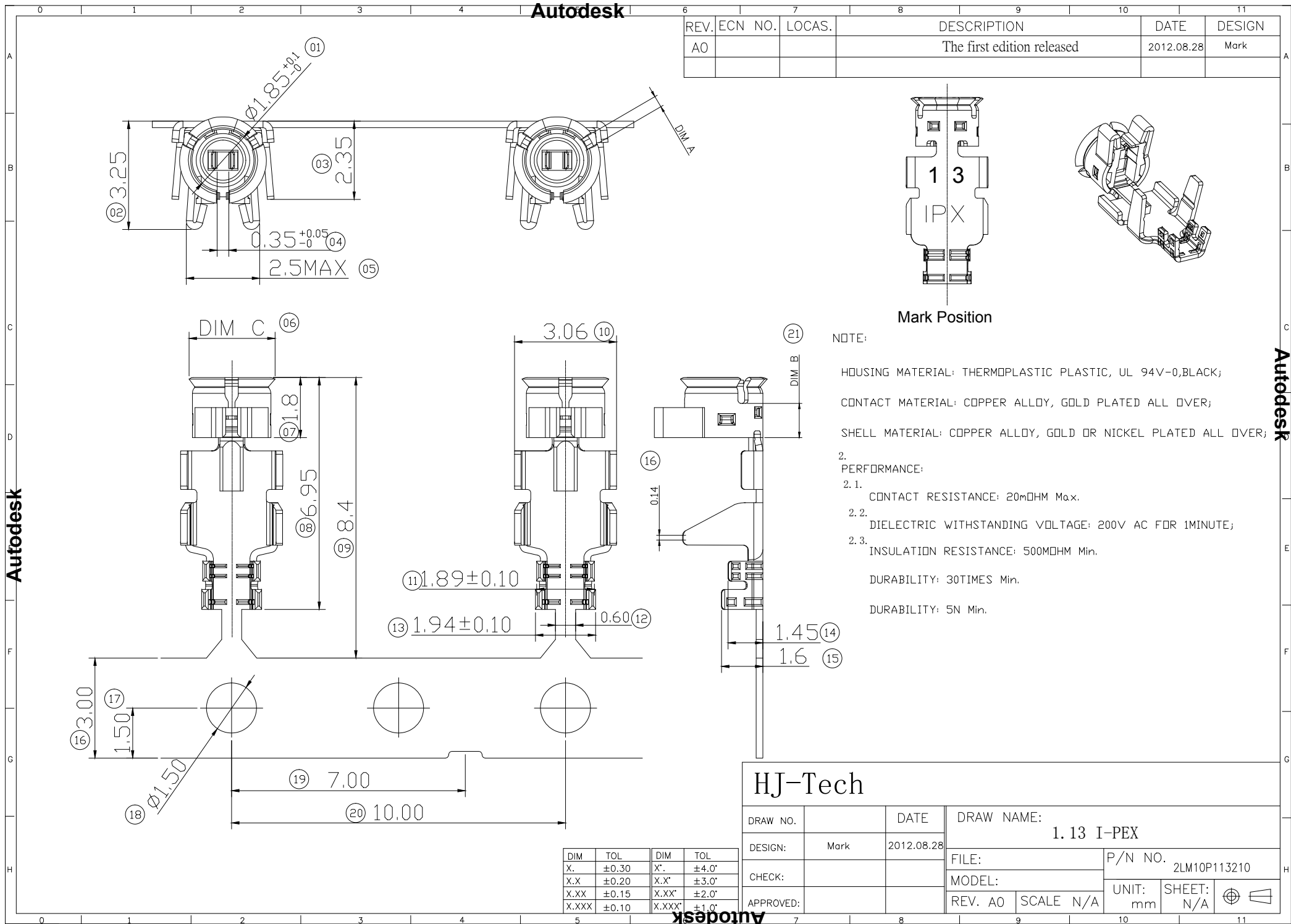
Prepared Date: 2022/11/29

Signature			
Customer		Supplier	
Confirmed by		Prepared by	S. He
Approved by		Checked by	Xiuming He
		Approved by	

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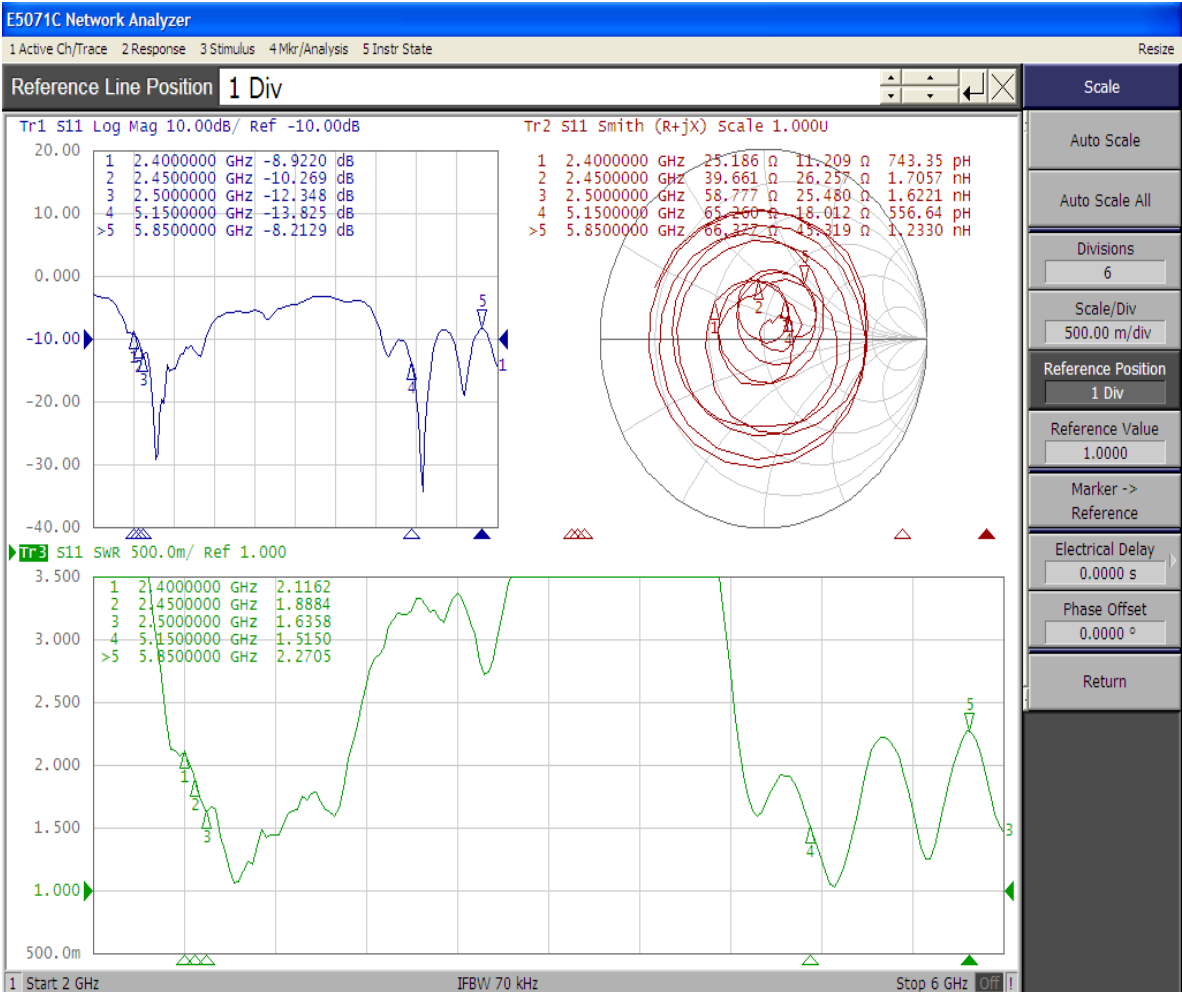
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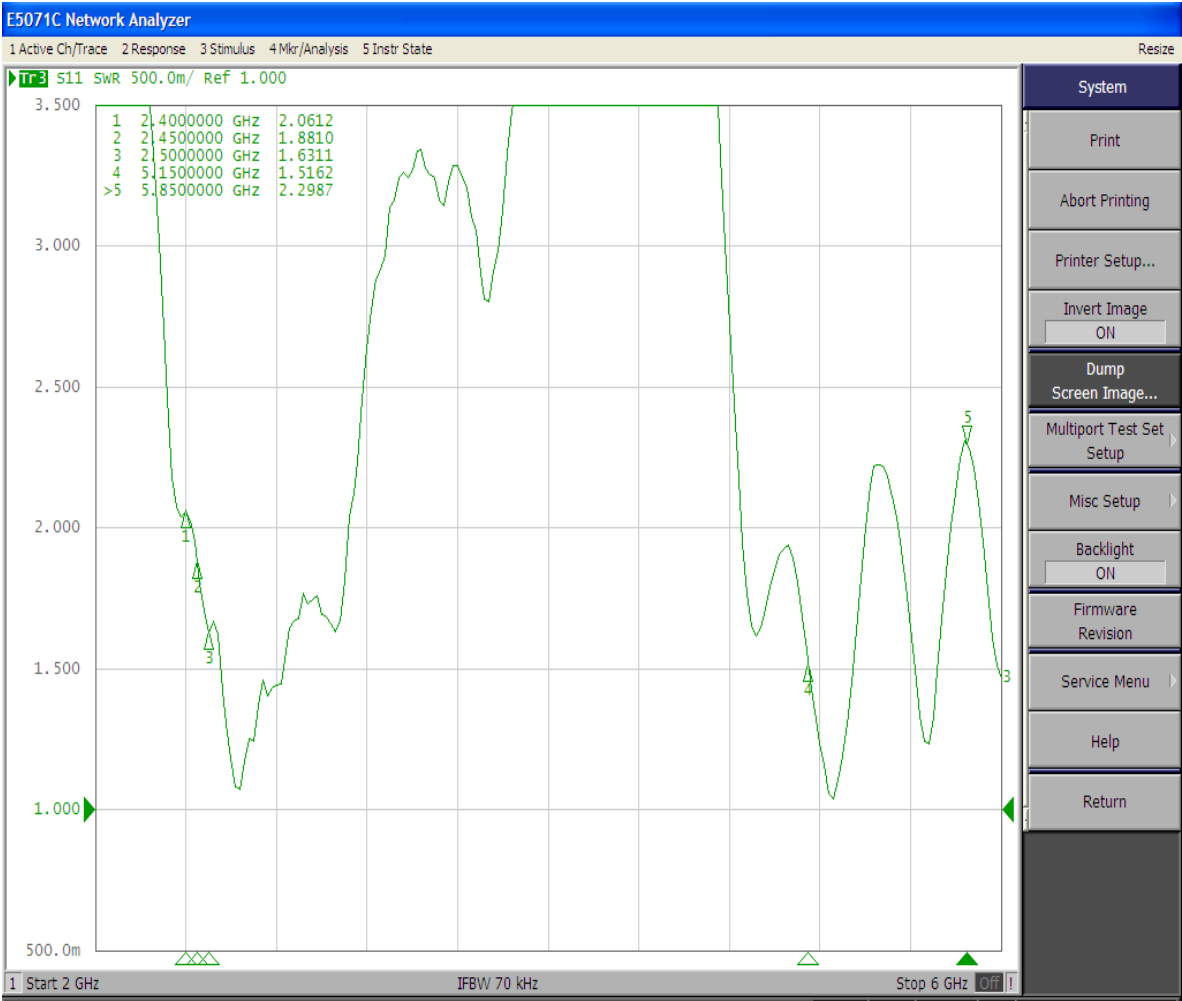


Type	RF-1.13/50	P/N	2C5M11312BK1 (Black)	
Structure drawing				
Structure characteristics				
Structure	Item		Standard value	
① Inner conductor	Material		Tinned copper wire	
	Makeup:total / O.D. of every wire(mm)		7/0.08	
	(Intertwist)NOM.O.D.(mm)		0.24±0.02	
② Insulation	Material		FEP	
	Color		Natural	
	NOM.O.D.(mm)		0.7±0.03	
③ Outer conductor	Material		Tinned copper wire	
	Makeup:total / O.D. of every wire(mm)		16/4/0.05	
	NOM.O.D.(mm)		0.92±0.05	
	Coverage ratio(%)		90±5	
④ Jacket	Material		FEP	
	Color		Black	
	NOM.O.D.(mm)		1.13±0.05	
Electrical characteristics				
Item	Standard value	Item	Frequency	Standard value Unit:dB/m
Capacitance(pF/m)	98	Attenuation	1GHz	≤2.32
Velocity(%)	70		2GHz	≤3.27
Impedance(Ω)	50±3		3GHz	≤4.01
Standing wave ratio	≤1.4@0~6GHz		4GHz	≤4.64
Max.operating voltage(V)	1000		5GHz	≤5.17
Max.operating frequency(GHz)	6		6GHz	≤5.70
Dependability				
Item		Unit	Standard value	
Min.bending radius static		mm	4	
Min.bending radius repeated		mm	—	
Operating temperature		℃	-55~+150	
Use tips				
Storage environment		30℃ 20%~65%		
Processing temperature		Under the limit condition of 260℃, it can bear for a short time; Above 300℃, the isothermal group of molecules will decompose. Significant thermal decomposition occurs above 400℃		

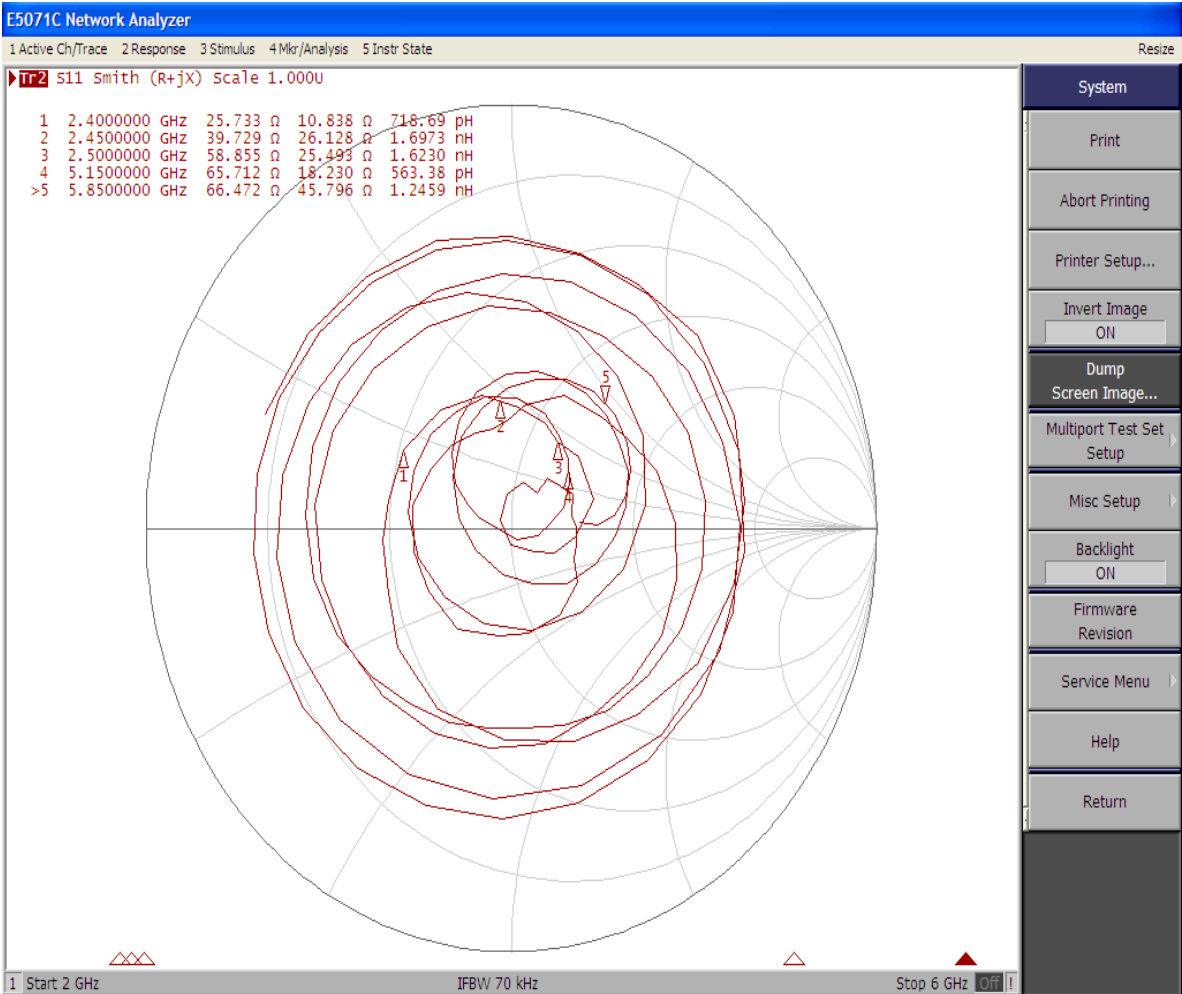
1 Test Report



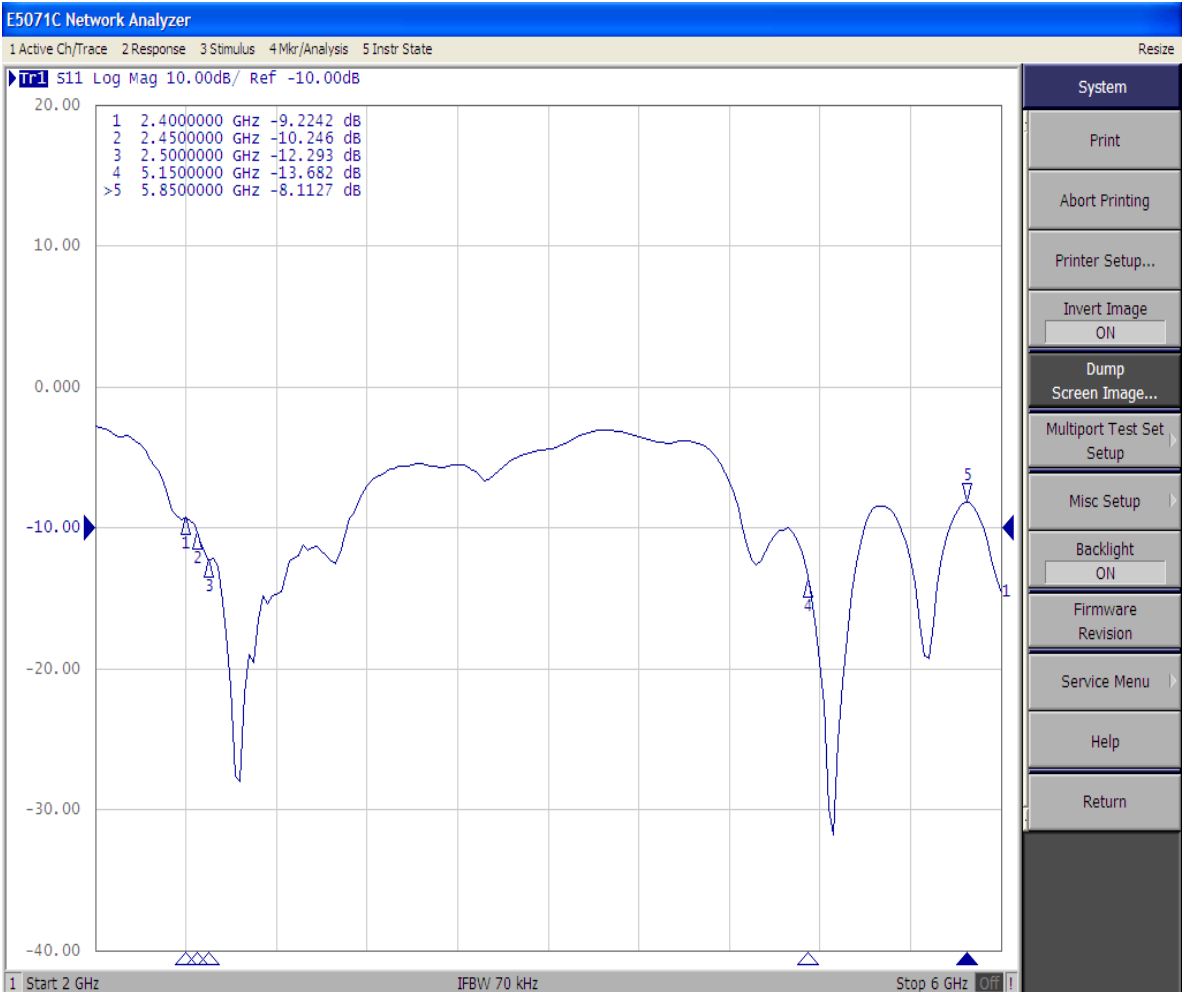
2 Test Report-VSWR



3 Test Report-SMITH CHART



4 Test Report-RETURN LOSS



Electrical characteristics test report
---darkroom

5 Test Report

FEITUKEJI																			
Frequency ID	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
Frequency (MHz)	2400.0	2410.0	2420.0	2430.0	2440.0	2450.0	2460.0	2470.0	2480.0	2490.0	2500.0	5150.0	5250.0	5350.0	5450.0	5550.0	5650.0	5750.0	5850.0
Point Values																			
Ant. Port Input Pwr. (dBm)	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00	0.00
Peak EIRP (dBm)	2.03	2.11	2.06	2.21	2.36	2.50	2.55	2.39	2.09	2.55	2.68	2.66	2.51	2.44	2.39	2.09	2.44	2.19	2.63
Directivity (dBi)	5.41	5.36	5.29	5.33	5.64	5.29	5.22	5.19	5.27	5.23	5.42	5.62	6.35	6.55	6.14	6.63	6.49	6.05	6.47
Efficiency (dB)	-2.53	-2.55	-2.69	-2.61	-2.66	-2.63	-2.51	-2.59	-2.66	-2.68	-2.58	-2.71	-2.61	-2.54	-2.33	-2.44	-2.44	-2.46	-2.33
Efficiency (%)	55.36	56.11	56.92	57.03	57.62	59.05	61.28	60.55	58.09	53.68	53.66	51.96	52.66	53.81	53.17	54.95	56.08	57.24	53.91
Gain (dBi)	2.78	2.92	2.78	2.83	2.73	2.50	2.49	2.63	2.51	2.48	2.37	1.76	2.86	2.38	1.70	2.18	1.47	1.40	0.75
NHPRP ±Pi/4 (dBm)	-3.84	-3.81	-3.94	-3.86	-3.91	-3.97	-3.92	-3.77	-3.93	-3.95	-4.01	-5.88	-5.54	-5.36	-5.34	-5.55	-6.32	-5.37	-6.08
NHPRP ±Pi/6 (dBm)	-5.43	-5.39	-5.54	-5.47	-5.53	-5.61	-5.57	-5.42	-5.58	-5.60	-5.65	-7.20	-6.87	-6.70	-6.73	-6.96	-7.68	-6.72	-7.45
NHPRP ±Pi/8 (dBm)	-6.60	-6.55	-6.71	-6.66	-6.73	-6.83	-6.80	-6.67	-6.85	-6.87	-6.91	-8.24	-7.94	-7.77	-7.81	-8.06	-8.72	-7.75	-8.47
Upper Hem. PRP (dBm)	-4.82	-4.85	-5.05	-5.04	-5.15	-5.24	-5.23	-5.11	-5.29	-5.35	-5.44	-8.44	-8.53	-8.58	-8.51	-8.86	-9.76	-8.65	-9.02
Lower Hem. PRP (dBm)	-6.36	-6.28	-6.37	-6.22	-6.20	-6.20	-6.11	-5.91	-6.05	-6.05	-6.09	-7.16	-6.56	-6.35	-6.38	-6.42	-6.98	-6.11	-6.95
Upper Hem. PRP (%)	32.96	32.76	31.28	31.37	30.58	29.90	29.99	30.85	29.55	29.18	28.57	14.32	14.01	13.87	14.09	13.00	10.56	13.64	12.53
Lower Hem. PRP (%)	23.10	23.55	23.08	23.87	24.00	23.96	24.51	25.64	24.83	24.84	24.63	19.22	22.08	23.16	23.02	22.81	20.04	24.47	20.16

